

MIC1232

5V Voltage Supervisor with Manual Reset, Watchdog Timer, and Dual Reset Outputs

Features

- Low-Current Version of DS1232, MAX1232, TC1232, CAT1232
- Low Current: 18 μA (typ.), 40 μA (max.)
- Selectable Threshold (TOL): 5% or 10% of 5V
- Selectable Watchdog Timer (TD): 150 ms, 600 ms, 1.2s
- Power OK/Reset Time Delay: 250 ms (min.)
- Debounced Pushbutton Reset Input (/PBRST)
- Dual Complementary Reset Outputs
 - Active-Low, Open-Drain Reset Output
 - Active-High, Push-Pull Reset Output
- Available in 8-lead SOIC and 8-Lead PDIP Packages
- -40°C to +85°C Temperature Range
- Pin-for-Pin Compatible with MIC1832, DS1832, CAT1832

Applications

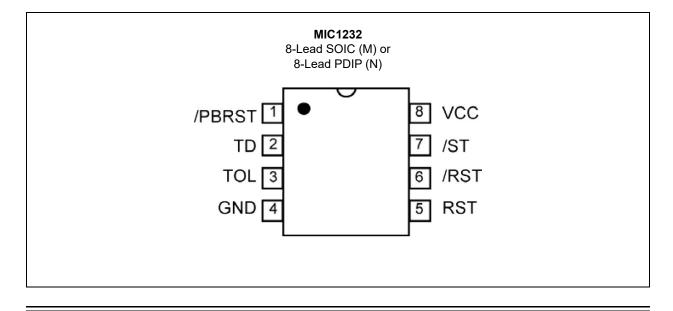
- Automotive Systems
- Intelligent Systems
- Critical Microprocessor Power Monitoring
- Battery Powered Computers
- Controllers

General Description

The MIC1232 is a low-current microprocessor supervisor for monitoring 5V systems. The device features logic selectable (TOL) reset thresholds of 5% or 10% of 5V; a pushbutton reset input (/PBRST); a watchdog timer with three-state selectable (TD) timeout periods of 150 ms, 600 ms, or 1.2s; a fixed reset timeout period of 250 ms (min.); and active-low open-drain reset (/RST) and active-high push-pull reset (RST) outputs. The /RST output maintains a valid reset condition for V_{CC} as low as 1.4V.

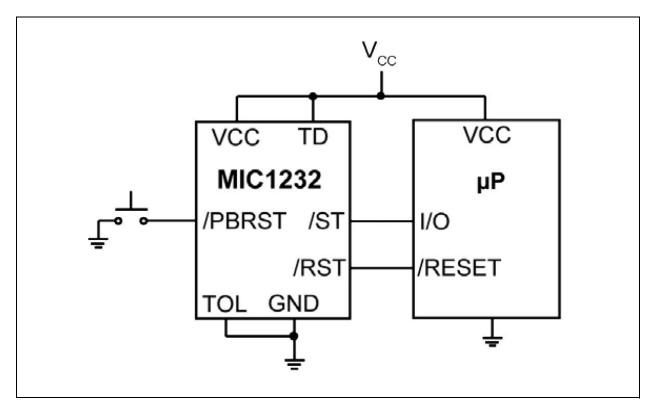
The MIC1232 asserts a reset condition if the supply voltage drops below the reset threshold, the pushbutton reset is asserted low, or the watchdog timer does not see a high-to-low transition on the watchdog timer input within the watchdog timer period. A reset condition is held for the reset timeout period of 250 ms (min.) after the pushbutton input is released or after the supply voltage increases above the reset threshold voltage.

The MIC1232 is a drop-in replacement for the DS1232, MAX1232, and TC1232. It consumes a low 18 μ A (typ.) of supply current, 40 μ A (max.). This is one-tenth the max current of the DS1232, and one-quarter the max current of the MAX1232 and TC1232. It operates over the –40°C to +85°C temperature range and is available in the 8-lead SOIC and PDIP packages.

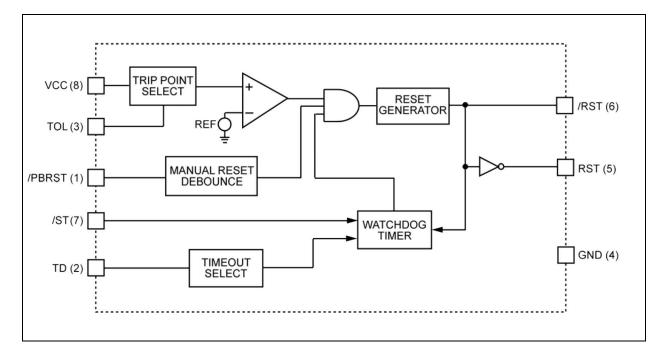


Package Types

Typical Application Circuits



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Terminal Voltage	
V _{CC}	
All other inputs	–0.3V to (V _{CC} + 0.3V)
Input Current	
V _{CC}	
GND, all other inputs	
ESD Rating	Note 1

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: Devices are ESD sensitive. Handling precautions recommended. Human body model, 1.5k in series with 100 pF.

V_{CC} = 4.5 V to 5.5V; T_A = Operating Temperature Range; bold values indicate –40°C ≤ T_A ≤ +85°C, unless noted.								
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions		
Supply Voltage Range	V _{CC}	4.5	_	5.5	V	—		
Supply Current	I _{CC}	_	18	40	μA	Note 1		
/ST and /PBRST Input	V _{IH}	2.0	_	V _{CC} + 0.3	V	Note 2		
Levels	V _{IL}	-0.3	_	0.8	V	—		
Input Leakage	I _{IL}	_	_	±1	μA	—		
Output Source Current, RST	I _{SOURCE}	1.0	10		mA	V _{OH} = 2.4V		
Output Sink Current, /RST. RST	I _{OSK}	2.0	10	_	mA	V _{OL} = 0.4V		
VCC 5% Trip Point (Reset Threshold Voltage)	V _{CCTP}	4.5	4.62	4.74	V	TOL = GND		
VCC 10% Trip Point (Reset Threshold Voltage)	V _{CCTP}	4.25	4.37	4.49	V	TOL = V _{CC}		
Input Capacitance, /ST, TOL	C _{IN}	—	_	5	pF	Note 3		
Output Capacitance, /RST, RST	C _{OUT}	_		7	pF	Note 3		

ELECTRICAL CHARACTERISTICS

Note 1: I_{CC} is measured with outputs open and inputs within 0.5V of supply rails.

2: /PBRST has an internal pull-up resistor to V_{CC} (typ. 40 k Ω).

3: Guaranteed by design.

AC ELECTRICAL CHARACTERISTICS

V _{IN} = 4.5V to 5.5V; T _A = Operating Temperature Range; bold values indicate –40°C≤ T _A ≤ +85°C, unless noted.								
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions		
/PBRST Min. Pulse Width	t _{PB}	20	—	_	ms	/PBRST = V _{IL} (Note 1)		
/PBRST Delay	t _{PBD}	1	4	20	ms	_		
Reset Active Time	t _{RST}	250	610	1000	ms	—		
/ST Pulse Width	t _{ST}	20			ns	—		
		62.5	150	250	ms	TD = 0V		
/ST Timeout Period	t _{TD}	250	600	1000	ms	TD = Open		
		500	1200	2000	ms	TD = V _{CC}		
VCC Fall Time	t _F	10			μs	—		
VCC Rise Time	t _R	0			ns	—		
VCC Detect to /RST Low and RST High	t _{RPD}		50	150	μs	V _{CC} Falling (Note 2)		
VCC Detect to /RST Low and RST Low	t _{RPD}	250	610	1000	ms	V _{CC} Falling (Note 3)		

Note 1: /PBRST must be held low for a minimum of 20ms to guarantee a reset.

2: V_{CC} falling at 1.66mV/µs.

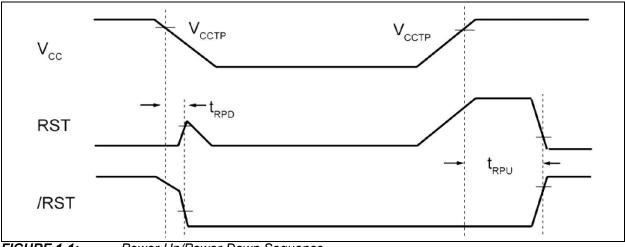
3: /RST has an open drain output

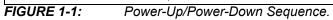
TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Operating Junction Temperature Range (Note 1)	TJ	-40	_	+85	°C		
Lead Temperature	_	_	_	+300	°C	Soldering, 10 seconds	
Storage Temperature	Τ _S	-65	_	+150	°C	—	

Note 1: The device is not guaranteed to function outside its operating ratings.

Timing Diagrams





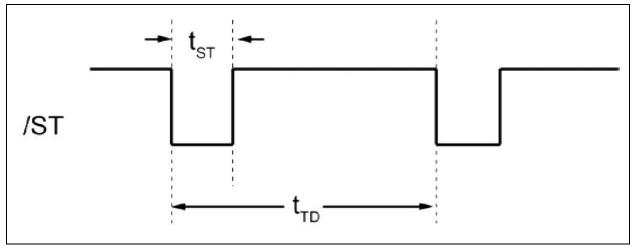
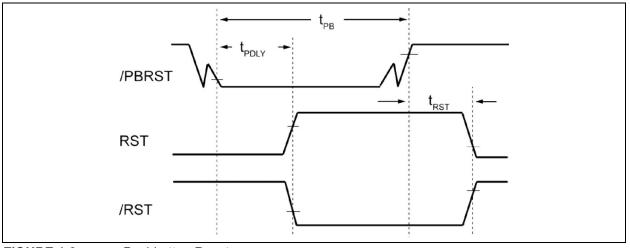
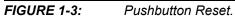


FIGURE 1-2: Watchdog Input.





2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1 :	PIN FUNCTION TABLE
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Pin Number	Pin Name	Description
1	/PBRST	Pushbutton Reset input: This input is debounced and can be driven with external logic signals or by using a mechanical pushbutton to actively force a reset. All pulses less than 1ms in duration on the /PBRST pin are ignored; any pulse with a duration of 20ms or greater is guaranteed to cause a reset.
2	TD	Time Delay input: This input selects the timebase used by the watchdog timer. When $TD = 0V$, the watchdog timeout period is set to a nominal value of 150ms. When $TD =$ open, the watchdog timeout period is set to a nominal value of 600ms. When $TD = VCC$, the watchdog period is 1.2s nominally.
3	TOL	Tolerance Select input: This input selects whether 5% or 10% of VCC is used as the reset threshold voltage. When TOL = 0V, the 5% tolerance level is selected and when TOL = VCC, a 10% tolerance level is selected.
4	GND	IC ground pin, 0V reference.
5	RST	RST is asserted high if either VCC goes below the reset threshold, the watchdog times out, or /PBRST is pulled low for a minimum of 20ms. RST remains asserted for one reset timeout period after VCC exceeds the reset threshold, after the watchdog times out, or after /PBRST goes high.
6	/RST	/RST is asserted low if either VCC goes below the reset threshold, the watchdog times out, or /PBRST is pulled low for a minimum of 20ms. /RST remains asserted for one reset timeout period after VCC exceeds the reset threshold, after the watchdog times out, or after /PBRST goes high. Open-drain output.
7	/ST	Input to watchdog timer. If /ST does not see a transition from high to low within the watchdog timeout period, RST and /RST will be asserted.
8	VCC	Primary supply input, +5V.

3.0 APPLICATION INFORMATION

3.1 Power Monitor

The /RST and RST pins are asserted whenever V_{CC} falls below the reset threshold voltage determined by the TOL pin. A 5% tolerance level (4.62V reset threshold voltage) can be selected by connecting the TOL pin to ground. A 10% tolerance level can be selected by connecting the TOL pin to the VCC pin. The reset pins will remain asserted for a period of 250ms after V_{CC} has risen above the reset threshold voltage. The reset function ensures that the microprocessor is properly reset and powers up into a known condition after a power failure. /RST will remain valid with V_{CC} as low as 1.4V.

3.2 Watchdog Timer

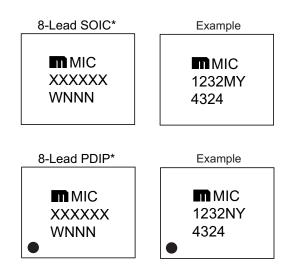
The microprocessor can be monitored by connecting the /ST pin (watchdog input) to a bus line or I/O line. If a high-to-low does not occur on the /ST pin within the watchdog timeout period determined by the TD pin (see the Electrical Characteristics Table), the /RST and the RST will remain asserted for 250 ms. A minimum pulse of 20 ns or any transition high-to-low on the /ST pin resets the watchdog timer. The watchdog timer is reset if /ST sees a valid transition within the watchdog timeout period.

3.3 Pushbutton Reset Input

The /PBRST input can be driven with a manual pushbutton switch or with external logic signals. The input is internally debounced and requires an active low signal to force the reset outputs into their active states. The /PBRST input recognizes any pulse that is 20 ms or longer in duration and ignores all pulses that are less than 1 ms in duration.

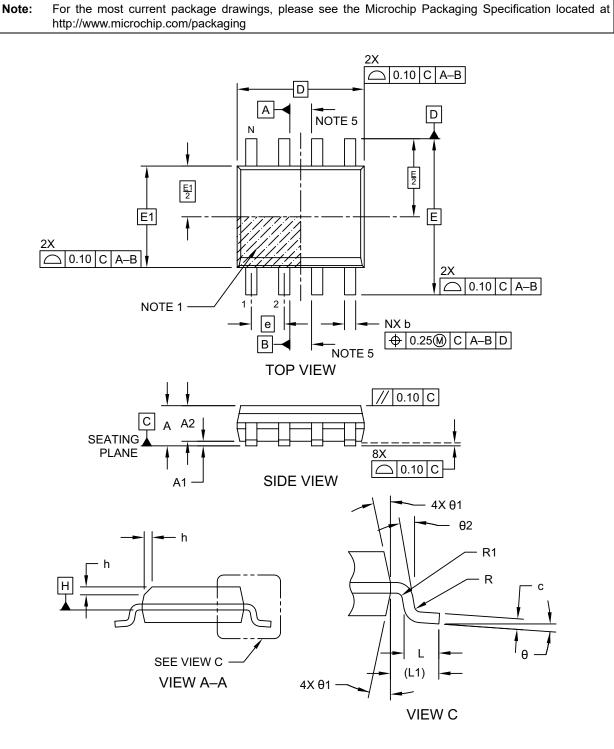
4.0 PACKAGING INFORMATION

4.1 Package Marking Information



Legend:	Y YY WW NNN @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
	be carried characters the corpor	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available of or customer-specific information. Package may or may not include ate logo. (_) and/or Overbar (⁻) symbol may not be to scale.

Note: If the full seven-character YYWWNNN code cannot fit on the package, the following truncated codes are used based on the available marking space:
6 Characters = YWWNNN; 5 Characters = WWNNN; 4 Characters = WNNN; 3 Characters = NNN; 2 Characters = NN; 1 Character = N.

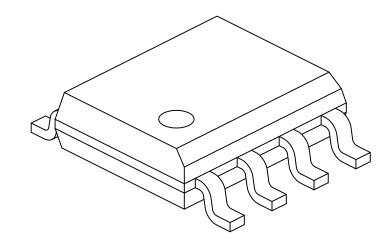


8-Lead 3.9 mm SOIC Package Outline and Recommended Land Pattern

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8-Lead 3.9 mm SOIC Package Outline and Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



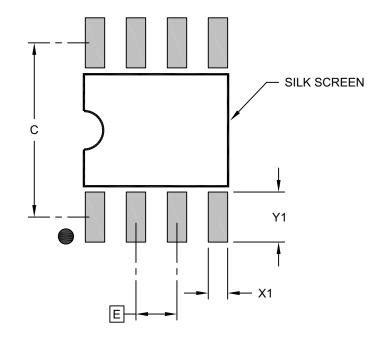
	MILLIMETERS				
Dimension	MIN	NOM	MAX		
Number of Pins	N		8		
Pitch	е		1.27 BSC		
Overall Height	Α	-	-	1.75	
Molded Package Thickness	A2	1.25	-	-	
Standoff §	A1	0.10	-	0.25	
Overall Width	E	6.00 BSC			
Molded Package Width	E1	3.90 BSC			
Overall Length	D	4.90 BSC			
Chamfer (Optional)	h	0.25	-	0.50	
Foot Length	L	0.40	-	1.27	
Footprint	L1		1.04 REF		
Lead Thickness	С	0.17		0.25	
Lead Width	b	0.31	-	0.51	
Lead Bend Radius	R	0.07 – –			
Lead Bend Radius	R1	0.07 – –			
Foot Angle	θ	0° – 8°			
Mold Draft Angle	θ1	5° – 15°			
Lead Angle	θ2	0°	_	8°	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A & B to be determined at Datum H.

8-Lead 3.9 mm SOIC Package Outline and Recommended Land Pattern

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	E		1.27 BSC	
Contact Pad Spacing	С		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

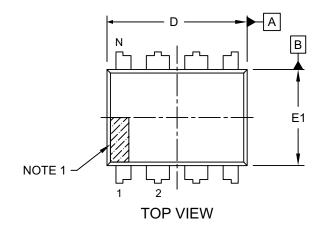
Notes:

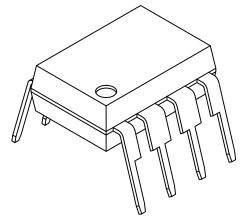
1. Dimensioning and tolerancing per ASME Y14.5M

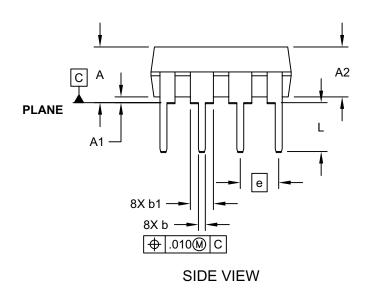
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

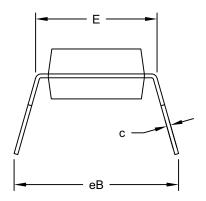
8-Lead 0.300 in PDIP Package Outline and Recommended Land Pattern

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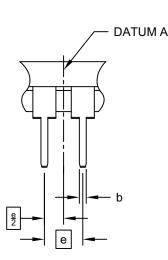


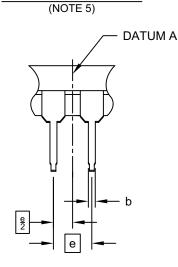




8-Lead 0.300 in PDIP Package Outline and Recommended Land Pattern

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ALTERNATE LEAD DESIGN

	INCHES			
Dimension	Dimension Limits			
Number of Pins	Ν		8	
Pitch	е		.100 BSC	
Top to Seating Plane	Α	-	-	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	-	-
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.348	.365	.400
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.040	.060	.070
Lower Lead Width	.014	.018	.022	
Overall Row Spacing §	eB	-	-	.430

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- 5. Lead design above seating plane may vary, based on assembly vendor.

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (September 2022)

- Converted Micrel document MIC1232 to Microchip data sheet DS20006726A.
- Minor text changes throughout.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART No.	x	х	-XX	Example	es:	
Device	– Package	Junction Temp. Range	Media Type	a) MIC1	232MY:	MIC1232, –40°C to +185°C Temp. Range, 8-Lead SOIC, 95/Tube
Device:	MIC1232:		ervisor with Manual Res r and Dual Reset Output	b) MIC1	232NY:	MIC1232, –40°C to +185°C Temp. Range, 8-Lead PDIP, 50/Tube
Package:	M = N =	8-Lead SOIC 8-Lead PDIP		c) MIC1	232MY-TR:	MIC1232, –40°C to +185°C Temp. Range, 8-Lead SOIC, 2500/Reel
Junction Temperature Range:	Y =	–40°C to +185°C		Note 1:		identifier only appears in the mber description. This identifier is
Media Type:	<blank>= <blank>= TR =</blank></blank>		lý)		used for order the device pac	ng purposes and is not printed on kage. Check with your Microchip r package availability with the

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